Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	685	Hall with threshold	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/15 17:44
L2	246	((Hall near effect) or (Hall near IC) or (Hall near chip) or (hall near integrated near circuit)) with threshold	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/15 17:59
L3	12	((Hall near effect) or (Hall near IC) or (Hall near chip) or (hall near integrated near circuit)) with threshold with hysteresis	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/15 18:02
L4	2104	335/205-208.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/15 18:03
L5	2104	(335/205-208).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/15 18:03
S1	3	("3673526"|"4346360"|"5656982").PN.	US-PGPUB; USPAT	OR	OFF	2006/01/15 17:43
S2	2	("6771155").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/29 09:58
S3	3	("3673526" | "4346360" | "5656982").PN. OR ("6771155").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/29 10:31
S4	2095	335/205-208.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:00

S5	199240	hall	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/29 10:31
S6	166	S4 and S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/29 10:31
S7	25131	injection near hole	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:00
S8	2095	335/205-208.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 09:25
S9	2	S7 and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:00
S10	350	(injection near hole) with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:01
S11	49390	"335"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:01
S12	1	S10 and S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:25

S13	53	(injection near hole) with (lead and resin)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:06
S14	0	(injection near hole) with (lead and resin and lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:06
S15	18	(injection near hole) with (resin and lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:11
S16	3	(injection near hole) with ((potting pot) and lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:12
S17	2	(injection near hole) with ((filler) and lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 07:13
S18	57	(wire or cord or lead) with (lid and hole) with (filler or resin or potting)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:15
S19	1	(wire or cord or lead) with (lid and hole) with (inject or injection) with (filler or resin or potting)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:16
S20	57	(wire or cord or lead) with (lid and hole) with (filler or resin or potting)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:17

S21	2	("5278357").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 07:25
S22	20	("1742312" | "4332975" | "4454381" | "4607469").PN. OR ("5278357").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/01 07:25
S23	11	("2206489" | "4041241" | "4313030" | "4454381" | "5278357" | "5353492"). PN. OR ("5561273").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/01 08:41
S24	47	(hole or opening) near (lid or cover) with (resin or potting or fixing) with (lead or cord)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 08:51
S25	288	336/96.ccls. and 336/192.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 08:53
S26	32735	injection near3 hole	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 08:53
S27	0	S25 and S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 08:53
S28	1395	336/96.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 08:53
S29	65667	(injection or injecting or filling) near3 hole	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:26

S30	12	S28 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 08:53
S31	37	("2829426" | "3838316" | "4177439" | "4185163" | "4335932" | "4366345" | "4507633" | "4528616").PN. OR ("4594644").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/01 08:56
S32	129245	"200"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 09:24
S33	2095	335/205-208.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 09:25
S34	130437	S32 or S33	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 09:25
S35	116504	(injection or injecting or filling) near3 (hole opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:26
S36	201	S34 and S35	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:26
S37	5956	(injection or injecting or filling) near3 (hole opening) with (cover or lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:29
S38	22	S34 and S37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:26

S39	2497	(injection or injecting or filling) near3 (resin or potting) with (cover or lid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 09:30
S40	12	S34 and S39	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 10:07
S41	11062	epoxy with (silicon and resin)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/01 10:08